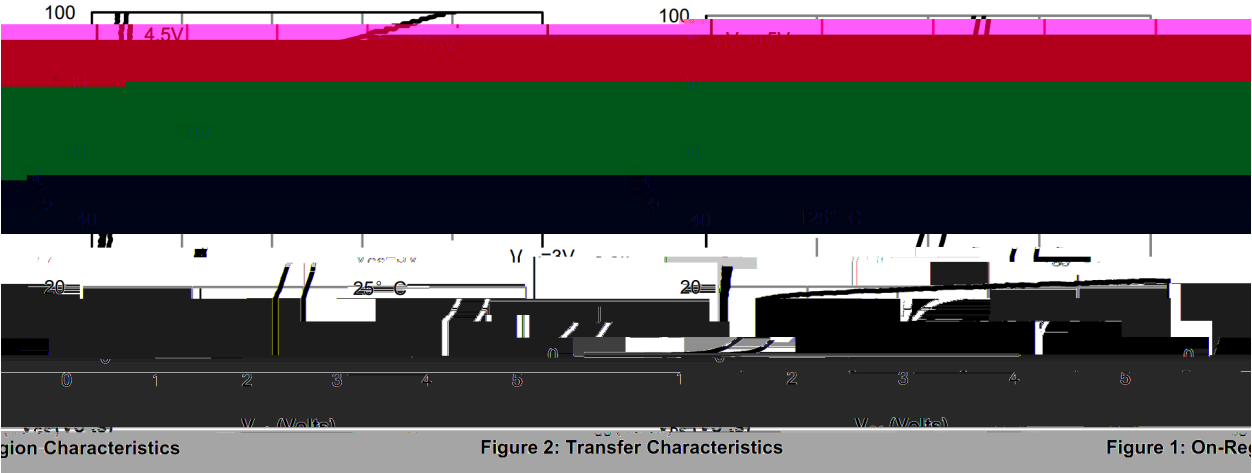
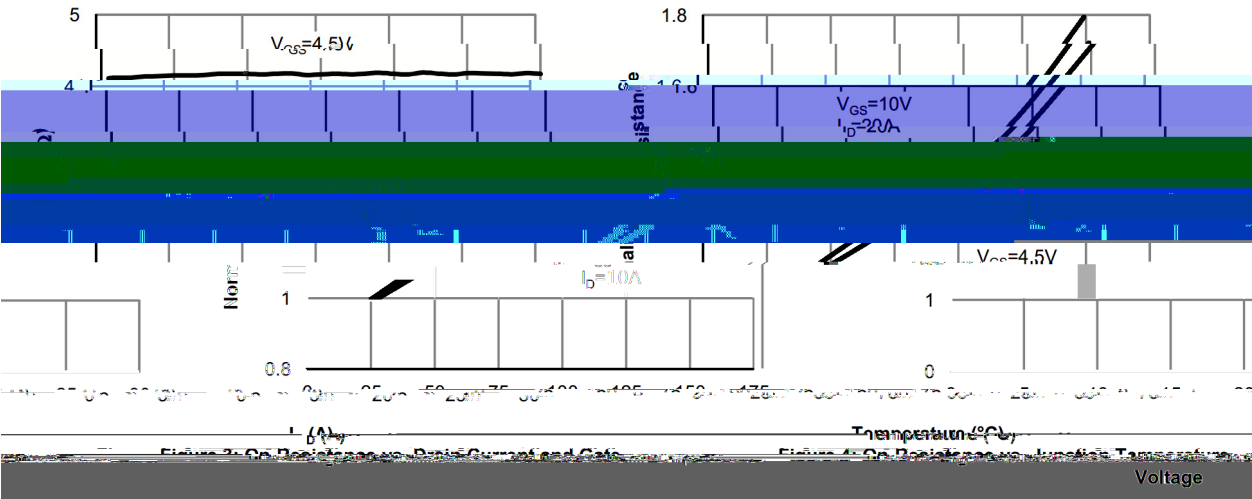
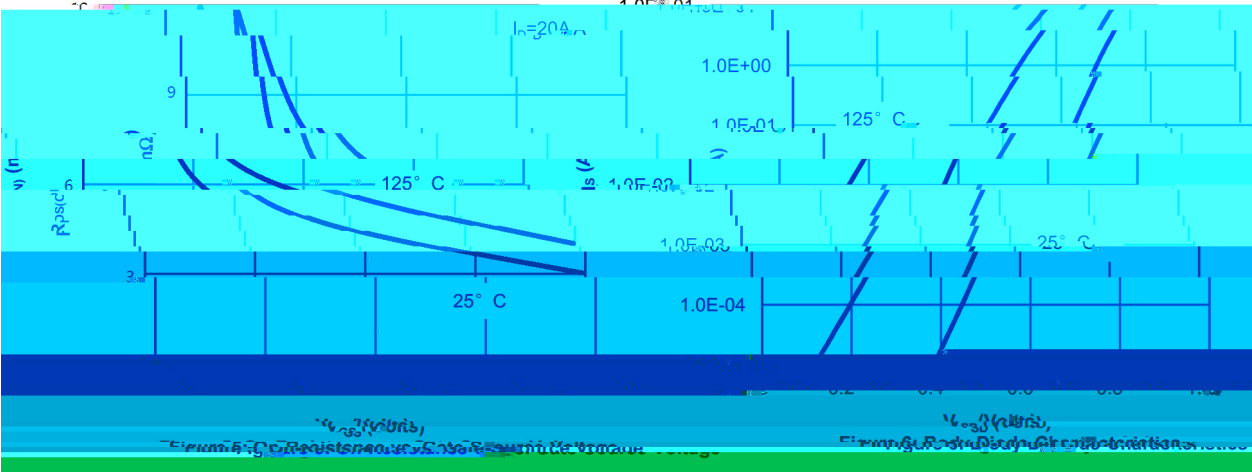


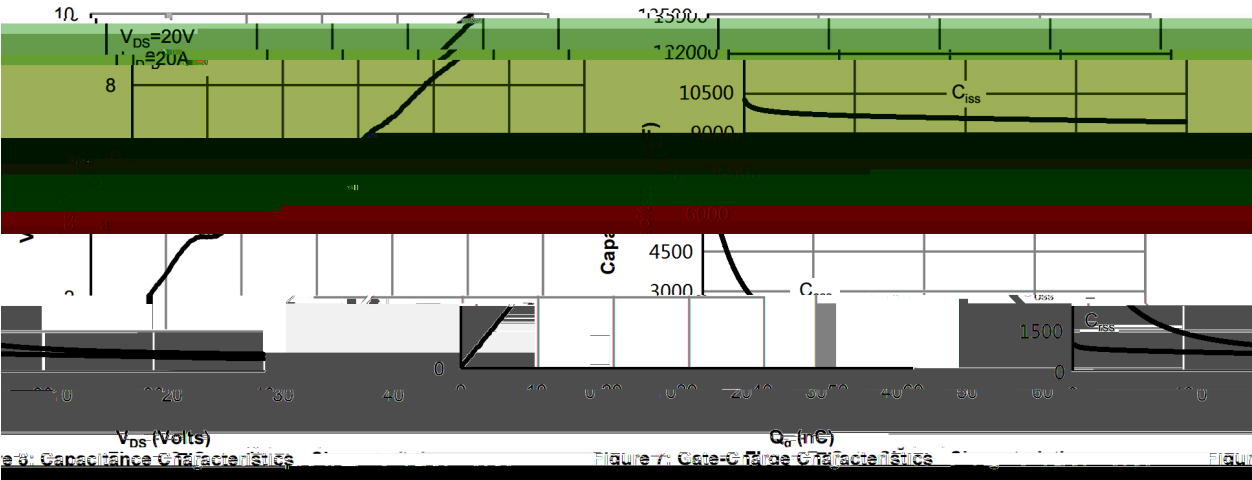
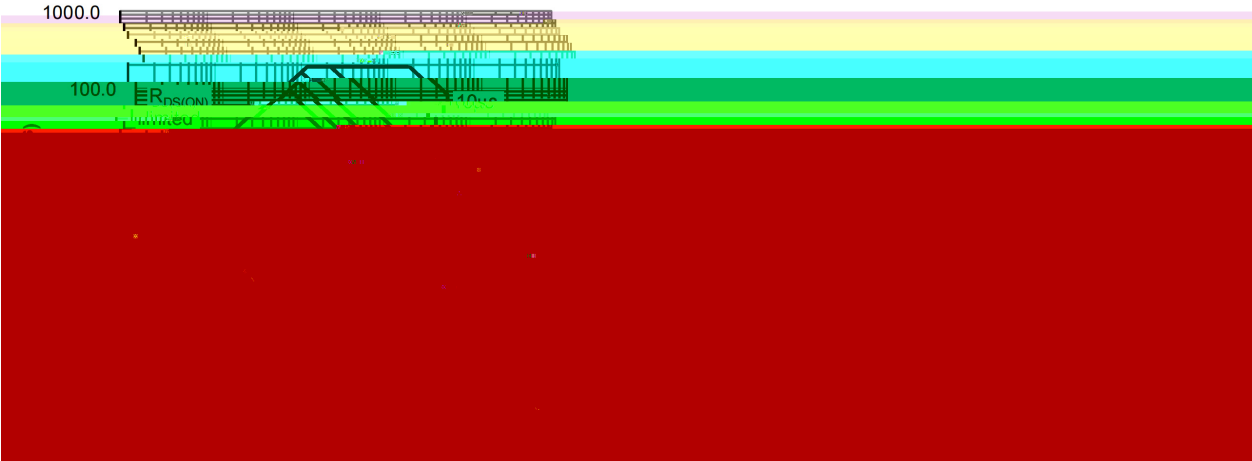
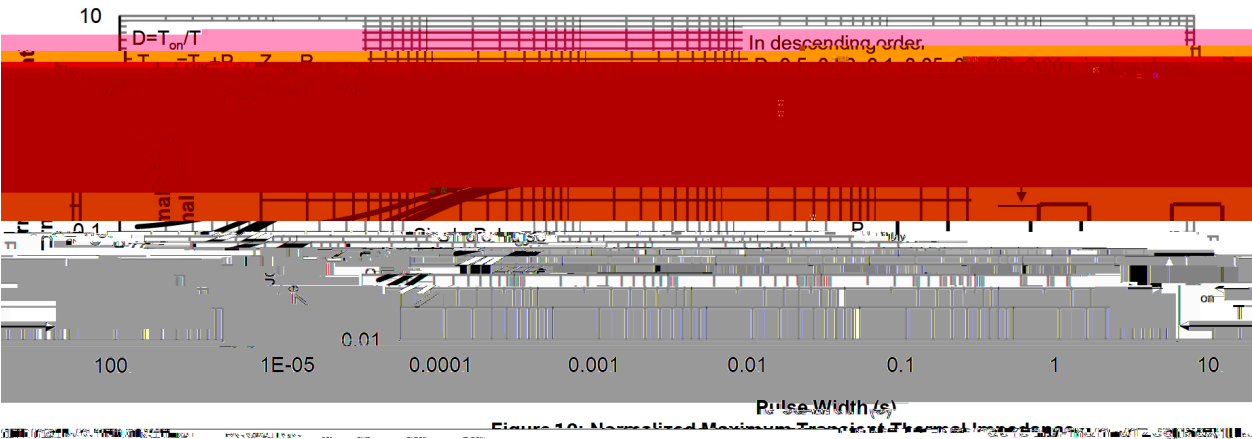
/ Electrical Characteristics(Ta=25)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Turn-On Delay Time	t _{d(on)}	V _{GS} =10V V _{DS} =20V R _L =1Ω R _{GEN} =3Ω		11		ns
Turn-On Rise Time	t _r			11		
Turn-Off Delay Time	t _{d(off)}			40		
Turn-Off Fall Time	t _f			10		

/ Electrical Characteristic Curve



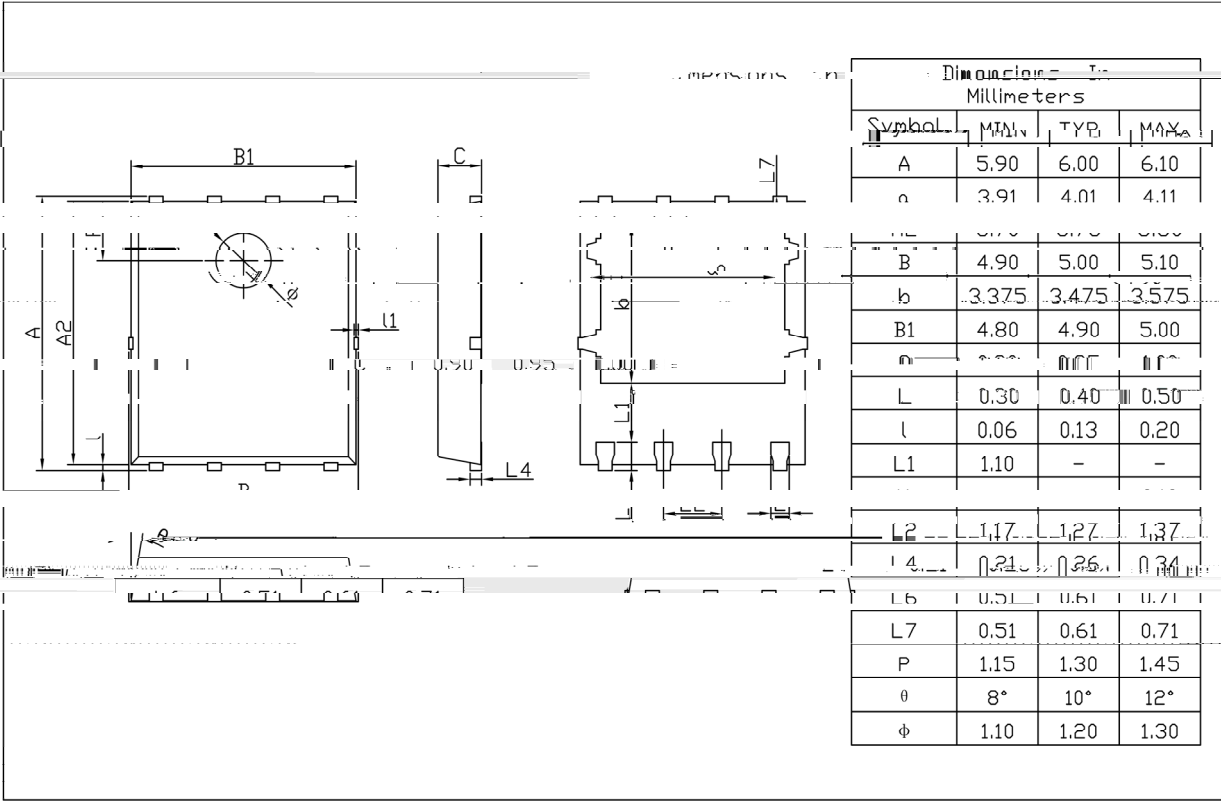
Electrical Characteristic Curve



/ Package Dimensions

PDFN5 X6

Unit:mm



Rev.01 202209

/ Marking Instructions



EU	
035N04S	

Note	
BR	Company Code
035N04S	Product Type Code
****:	Lot No. Code, code change with Lot No

() / Temperature Profile for IR Reflow Soldering(Pb-Free)

备注

1. 预热: 150~180℃, 时间: 60~90sec;
2. 峰值温度: 245±5℃, 持续时间: 5~10sec;
3. 冷却速度: 2~10℃/sec.

Note:

- 1.Preheating:150~180℃, Time:60~90sec.
- 2.Peak Temp.:245±5℃, Duration:5~10sec.
3. Cooling Speed: 2~10℃/sec.

/ Resistance to Soldering Heat Test Conditions

锡焊温度: 260±5℃ 时间: 10±1 sec. Temp.:260±5 Time:10±1 sec

/ Packaging SPEC.

包装形式 / REEL

Package Type	Units	Dimension	(unit mm ³)
封装形式			